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I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the United States Postal Service with sufficient postage for first class mail in an envelope addressed to the Box AF: Expedited Procedure address below, or being transmitted via facsimile to (703) 872-9319 at the U.S. Patent and Trademark Office to the Attention of Examiner Ahmed N. Sefer on December 10, 2002.

Andrew Romero
Andrew Romero

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

FAX RECEIVED

In re patent application of:

Applicant: Dong-Hyuk Ju et al.

Serial No: 09/879,724

Filing Date: June 12, 2001

DEC 10 2002

Art Unit: 2826

TECHNOLOGY CENTER 2800

Examiner: Ahmed N. Sefer

Title: **LEAKY, THERMALLY CONDUCTIVE INSULATOR MATERIAL (LTCIM)
IN SEMICONDUCTOR-ON-INSULATOR (SOI) STRUCTURE**

Box AF: Expedited Procedure
Commissioner for Patents
U.S. Patent and Trademark Office
Washington, D.C. 20231

REPLY AFTER FINAL--
EXPEDITED HANDLING
REQUESTED

REPLY TO OFFICE ACTION DATED OCTOBER 7, 2002

Dear Sir:

Favorable reconsideration of the above-identified application is respectfully requested in view of the following amendments and comments. It is believed that the amendments contained herein raise no new issues, do not require an additional search and place the application in a better condition for allowance and/or appeal. Accordingly, entry of the amendment is considered proper.